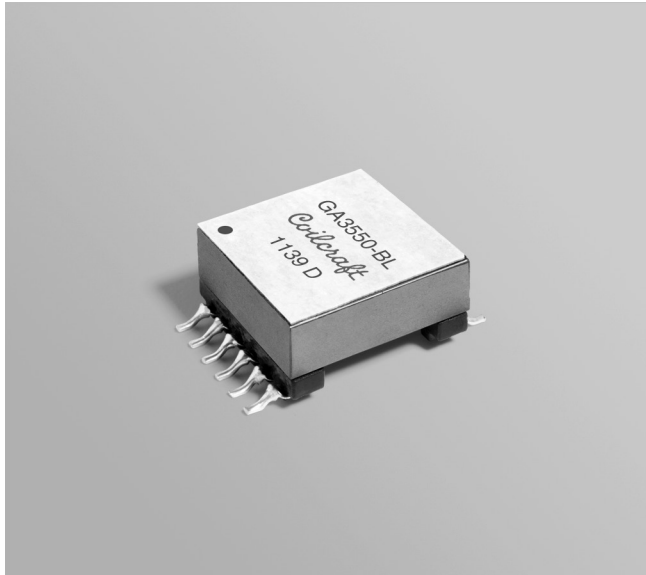


Gate Drive Transformer

For use with TI UCD3138
Digital Power Controllers



- Selected by Texas Instruments for their UCD3138 evaluation boards.
- Designed to meet UL/CSA/IEC 60950 Reinforced Insulation specification; 3.0 mm creepage and clearance.
- Isolation: 3000 Vrms primaries to secondary; 500 Vrms windings to core

Core material Ferrite

Terminations RoHS compliant tin-silver over tin over nickel over phos-bronze.

Weight 6.3 g

Ambient temperature -40°C to $+85^{\circ}\text{C}$

Maximum part temperature $+125^{\circ}\text{C}$ (ambient + temp rise)

Storage temperature Component: -40°C to $+125^{\circ}\text{C}$.

Packaging: -40°C to $+80^{\circ}\text{C}$

Moisture Sensitivity Level (MSL) 1 (unlimited floor life at $<30^{\circ}\text{C}$ / 85% relative humidity)

Failures in Time (FIT) / Mean Time Between Failures (MTBF)

38 per billion hours / 26,315,789 hours, calculated per Telcordia SR-332

Packaging 200/13" reel Plastic tape: 44 mm wide, 0.4 mm thick, 24 mm pocket spacing, 10.56 mm pocket depth

PCB washing Tested to MIL-STD-202 Method 215 plus an additional aqueous wash. See [Doc787_PCB_Washing.pdf](#).

Part number ¹	Turns ratio	Primary inductance ² $\pm 25\%$ (μH)	Leakage inductance ³ max (μH)	DCR max (Ohms)	Volt-time product ⁴ (V- μsec)	SRF typ ⁵ (MHz)	Capacitance max (pF)
GA3550-BL_	1 : 1 : 1	460	1.15 (Pri [A]) 1.25 (Pri [B])	0.410 (Pri [A]) 0.475 (Pri [B]) 0.440 (sec)	165	5.85	34.0 (1 – 10) 10.5 (1 – 5)

1. When ordering, please specify a **packaging** code:

GA3550-BLD

Packaging: **D** = 13" machine ready reel. EIA-481 embossed plastic tape (200 parts per full reel).

B = Less than full reel. In tape, but not machine ready.

To have a leader and trailer added (\$25 charge), use code letter D instead.

2. Inductance is for each winding, measured at 200 kHz, 0.4 Vrms, 0 Adc.

3. Leakage inductance is measured at 200 kHz, 0.4 Vrms with secondary pins shorted.

4. Volt-time product is per winding.

5. SRF is per winding, measured on an Agilent/HP 4192 or equivalent.

6. Electrical specifications at 25°C .

Refer to Doc 362 "Soldering Surface Mount Components" before soldering.

